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Tel: +86-755-8981 8866 Fax: +86-755-8427 6832 Email & Skype: info@chipsmall.com Web: www.chipsmall.com Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China





SigmaDSP Digital Audio Processor

Data Sheet

ADAU1463/ADAU1467

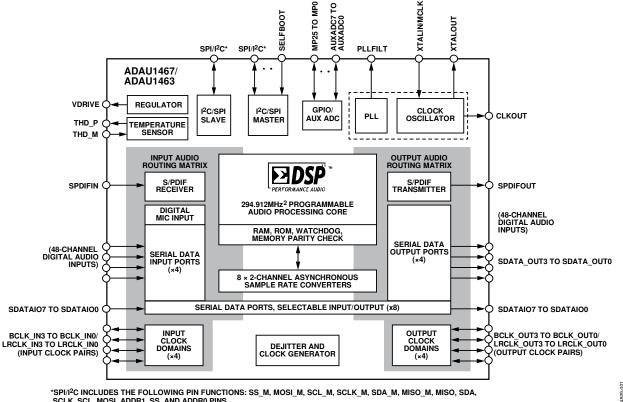
FEATURES

Qualified for automotive applications Fully programmable audio DSP for enhanced sound processing Features SigmaStudio, a proprietary graphical programming tool for the development of custom signal flows Up to 294.912 MHz, 32-bit SigmaDSP core at 1.2 V Up to 24 kWords of program memory Up to 80 kWords of parameter/data RAM Up to 6144 SIMD instructions per sample at 48 kHz Up to 1600 ms digital audio delay pool at 48 kHz Audio I/O and routing 4 serial input ports, 4 serial output ports 48-channel, 32-bit digital I/O up to a sample rate of 192 kHz Flexible configuration for TDM, I²S, left and right justified formats, and PCM 8 stereo ASRCs from 1:8 up to 7.75:1 ratio and 139 dB dynamic range Stereo S/PDIF input and output at 192 kHz 4 PDM microphone input channels Multichannel, byte addressable TDM serial ports

Clock oscillator for generating master clock from crystal Integer PLL and flexible clock generators Integrated die temperature sensor I²C and SPI control interfaces (both slave and master) Standalone operation Self boot from serial EEPROM 8-channel, 10-bit SAR auxiliary control ADC 26 multipurpose pins for digital controls and outputs On-chip regulator for generating 1.2 V from 3.3 V supply 88-lead, 12 mm × 12 mm LFCSP package with 5.3 mm exposed pad Temperature range: -40°C to +105°C **APPLICATIONS**

Automotive audio processing

- Head units
- **Distributed amplifiers**
- **Rear seat entertainment systems**
- **Trunk amplifiers**
- **Commercial and professional audio processing**



SCLK, SCL, MOSI, ADDR1, SS, AND ADDR0 PINS.

Fiaure 1.

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FUNCTIONAL BLOCK DIAGRAM

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Section and Table 39, Renumbered Sequentially54
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Added Table 80115
Changes to Table 143172
Changes to Figure 88206
Changes to Example PCB Layout Section and Figure 90207
Changes to the Ordering Guide Section

10/2017—Revision 0: Initial Version

GENERAL DESCRIPTION

The ADAU1463/ADAU1467 are automotive qualified audio processors that far exceed the digital signal processing capabilities of earlier SigmaDSP® devices. They are pin and register compatible with each other, as well as with the ADAU1450/ADAU1451/ADAU1452 SigmaDSP processors. The restructured hardware architecture is optimized for efficient audio processing. The audio processing algorithms support a seamless combination of stream processing (sample by sample), multirate processing, and block processing paradigms. The SigmaStudio[®] graphical programming tool enables the creation of signal processing flows that are interactive, intuitive, and powerful. The enhanced digital signal processor (DSP) core architecture enables some types of audio processing algorithms to be executed using significantly fewer instructions than were required on previous SigmaDSP generations, leading to vastly improved code efficiency.

The 1.2 V, 32-bit DSP core can run at frequencies of up to 294.912 MHz and execute up to 6144 single instruction, multiple data (SIMD) instructions per sample at the standard sample rate of 48 kHz. Powerful clock generator hardware, including a flexible phase-locked loop (PLL) with multiple fractional integer outputs, supports all industry standard audio sample rates. Nonstandard rates over a wide range can generate up to 15 sample rates simultaneously. These clock generators, along with the on-board asynchronous sample rate converters (ASRCs) and a flexible hardware audio routing matrix, make the ADAU1463/ADAU1467 ideal audio hubs that greatly simplify the design of complex multirate audio systems.

The ADAU1463/ADAU1467 have four input serial ports and four output serial ports. Each device has an asynchronous clock domain capable of operating as either a bit clock and frame sync master or slave. Each of the serial ports supports multiple data lines. The eight SDATAIOx pins each can be associated with any of the four input or four output serial ports. The use of assignable data pins allows a serial port to transmit or receive additional channels of audio data using a single bit clock and frame clock. Each of the supplemental data pins can carry from two to eight channels of serial audio. This flexible configuration provides more channels of audio input/output (I/O) without the need to run serial ports at high speed, and enables systems with additional serial audio peripherals. These expanded serial audio ports, along with the clock generators, the on-board asynchronous sample rate converters (ASRCs), and a flexible hardware audio routing matrix make the ADAU1463/ ADAU1467 ideal audio hubs that greatly simplify the design of complex, multirate audio systems.

The ADAU1463/ADAU1467 interface with a wide range of analog-to-digital converters (ADCs), digital-to-analog converters (DACs), digital audio devices, amplifiers, and control circuitry with highly configurable serial ports, I²C, serial peripheral interface (SPI), Sony/Philips Digital Interconnect Format (S/PDIF) interfaces, and multipurpose I/O pins. Dedicated decimation filters can decode the pulse density modulation (PDM) output of up to four MEMS microphones.

Independent slave and master I²C/SPI control ports allow the ADAU1463/ADAU1467 to be programmed and controlled by an external master device such as a microcontroller, and to program and control slave peripherals directly. Self boot functionality and the master control port enable complex standalone systems.

Note that throughout this data sheet, multifunction pins, such as SDATAIO4/MP20, are referred to either by the entire pin name or by a single function of the pin, for example, MP20, when only that function is relevant.

DIFFERENCES BETWEEN THE ADAU1463 AND ADAU1467

The two variants of this device are differentiated by memory and DSP core frequency. A detailed summary of the differences is listed in Table 1.

Table 1. Product Selection Table

Device	Data Memory (kWords)	Program Memory (kWords)	DSP Core Frequency (MHz)
ADAU1463WBCPZ300	48	16	294.912
ADAU1463WBCPZ150	48	16	147.456
ADAU1467WBCPZ300	80	24	294.912

SPECIFICATIONS

 $AVDD = 3.3 V \pm 10\%$, $DVDD = 1.2 V \pm 5\%$, $PVDD = 3.3 V \pm 10\%$, IOVDD = 1.8 V - 5% to 3.3 V + 10%, $T_A = 25^{\circ}$ C, master clock input = 12.288 MHz, core clock (f_{CORE}) = 294.912 MHz, I/O pins set to low drive setting, unless otherwise noted.

Parameter	Min	Тур	Max	Unit	Test Conditions/Comments
POWER		71			
Supply Voltage					
Analog Voltage (AVDD)	2.97	3.3	3.63	v	Supply for analog circuitry, including auxiliary ADCs
Digital Voltage (DVDD)	1.14	1.2	1.26	v	Supply for digital circuitry, including the DSP core, ASRCs, and signal routing
PLL Voltage (PVDD)	2.97	3.3	3.63	v	Supply for PLL circuitry
I/O Supply Voltage (IOVDD)	1.71	3.3	3.63	v	Supply for input/output circuitry, including pads and level shifters
Supply Current					
Analog Current (AVDD)	1.36	1.66	2	mA	
Idle State	1.00	1.10	40	μA	Power applied, chip not programmed
Reset State	1.00	1.10	40	μA	Power applied, RESET held low
PLL Current (PVDD)	8.3	10.1	12.9	mA	12.288 MHz MCLK with default PLL settings
Idle State	18.3	18.7	40	μA	Power applied, PLL not configured
Reset State	18.3	18.7	40	μA	Power applied, RESET held low
I/O Current (IOVDD)					Dependent on the number of active serial ports, clock pins, and characteristics of external loads
Operation State		53		mA	IOVDD = 3.3 V; all serial ports are clock masters
		22		mA	IOVDD = 1.8 V; all serial ports are clock masters
Power-Down State		4.1	4.2	mA	IOVDD = 1.8 V - 5% to 3.3 V + 10%
Digital Current (DVDD)					
ADAU1467 Operation State					
Maximum Program		233	495	mA	
Typical Program		220		mA	Test program includes 16-channel I/O, 10-band equalizer (EQ) per channel all ASRCs active
Minimal Program ADAU1463 Operation State $f_{CORE} = 294.912 \text{ MHz}$		213		mA	Test program includes 2-channel I/O, 10-band EQ per channel
Maximum Program		233	495	mA	
Typical Program		233	495	mA	Test program includes 16-channel I/O, 10-band EQ per channel, all ASRCs active
Minimal Program f _{CORE} = 147.456 MHz		213		mA	Test program includes 2-channel I/O, 10-band EQ per channel
Maximum Program		270	420	mA	
Typical Program		110	720	mA	Test program includes 16-channel I/O, 10-band EQ per channel
Minimal Program		90		mA	Test program includes 2-channel I/O, 10-band EQ per channel
Idle State	18.3	18.7	19.9	mA	Power applied, DSP not enabled
Reset State	18.3	18.7	19.9	mA	Power applied, RESET held low
ASYNCHRONOUS SAMPLE RATE CONVERTERS					
Dynamic Range		139		dB	A weighted, 20 Hz to 20 kHz
I/O Sample Rate	6		192	kHz	
I/O Sample Rate Ratio	1:8		7.75:1		
Total Harmonic Distortion Plus Noise (THD + N)			-120	dB	
CRYSTAL OSCILLATOR	1				
Transconductance	8.3	10.6	13.4	mS	
REGULATOR	1				
DVDD Voltage	1.14	1.2		V	Regulator maintains typical output voltage up to a maximum 800 mA load IOVDD = $1.8 \text{ V} - 5\%$ to $3.3 \text{ V} + 10\%$

AVDD = $3.3 \text{ V} \pm 10\%$, DVDD = $1.2 \text{ V} \pm 5\%$, PVDD = $3.3 \text{ V} \pm 10\%$, IOVDD = 1.8 V - 5% to 3.3 V + 10%, T_A = -40° C to $+105^{\circ}$ C, master clock input = 12.288 MHz, f_{CORE} = 294.912 MHz, I/O pins set to low drive setting, unless otherwise noted.

Parameter	Min	Тур	Max	Unit	Test Conditions/Comments
POWER		71			
Supply Voltage					
Analog Voltage (AVDD)	2.97	3.3	3.63	v	Supply for analog circuitry, including auxiliary ADCs
Digital Voltage (DVDD)	1.14	1.2	1.26	V	Supply for digital circuitry, including the DSP core, ASRCs, and signal routing
PLL Voltage (PVDD)	2.97	3.3	3.63	v	Supply for PLL circuitry
IOVDD Voltage (IOVDD)	1.71	3.3	3.63	v	Supply for input/output circuitry, including pads and level shifters
Supply Current					
Analog Current (AVDD)	1.36	1.66	2	mA	
Idle State	1.0	1.1	40	μA	
Reset State	1.0	1.1	40	μA	
PLL Current (PVDD)	8.3	10.2	15	mA	12.288 MHz master clock; default PLL settings
Idle State	18.4	18.7	40	μA	Power applied, PLL not configured
Reset State	18.4	18.7	40	μA	Power applied, RESET held low
I/O Current (IOVDD)					Dependent on the number of active serial ports, clock pins, and characteristics of external loads
Operation State		53		mA	IOVDD = 3.3 V; all serial ports are clock masters
operation state		22		mA	IOVDD = 1.8 V; all serial ports are clock masters
Power-Down State		4.1	4.3	mA	IOVDD = 1.8 V - 5% to $3.3 V + 10%$
Digital Current (DVDD)			1.5	110.0	
ADAU1467 Operation State					
Maximum Program		485	940	mA	
Typical Program		330	940	mA	Test program includes 16-channel I/O, 10-band EQ per channel, all ASRCs active
Minimal Program		213		mA	Test program includes 2-channel I/O, 10-band EQ per channel
ADAU1463 Operation State					
$f_{\text{CORE}} = 294.912 \text{ MHz}$					
Maximum Program		485	940	mA	
Typical Program		330	2.0	mA	Test program includes 16-channel I/O, 10-band EQ per channe all ASRCs active
Minimal Program		213		mA	Test program includes 2-channel I/O, 10-band EQ per channel
$f_{CORE} = 147.456 \text{ MHz}$		-			
Maximum Program		270	420	mA	
Typical Program		110		mA	Test program includes 16-channel I/O, 10-band EQ per channel, all ASRCs active
Minimal Program		90		mA	Test program includes 2-channel I/O, 10-band EQ per channel
Idle State	5.9	15.7	559	mA	
Reset State	5.9	15.7	559	mA	
ASYNCHRONOUS SAMPLE RATE CONVERTERS					
Dynamic Range		139		dB	A weighted, 20 Hz to 20 kHz
I/O Sample Rate	6		192	kHz	
I/O Sample Rate Ratio	1:8		7.75:1	-10	
THD + N	+		-120	dB	
	7.4	10.0	145		
	7.4	10.6	14.6	mS	
REGULATOR DVDD Voltage	1.14	1.2		v	Regulator maintains typical output voltage up to a maximum 800 mA load; IOVDD = 1.8 V – 5% to 3.3 V + 10%

ELECTRICAL CHARACTERISTICS

Digital Input/Output

Table 4.

Parameter	Min	Тур	Max	Unit	Test Conditions/Comments
DIGITAL INPUT					
Input Voltage					Excluding SPDIFIN, which is not a standard digital input
IOVDD = 3.3 V					
High Level (V _{IH})	1.71		3.3	v	
Low Level (V_{IL})	0		1.71	V	
IOVDD = 1.8 V	Ŭ		1.7 1		
High Level (V_{H})	0.92		1.8	v	
Low Level (VII)	0.92		0.89	v	
	0		0.09	v	
Input Leakage			2		Divited in a state of the second state of the
High Level (I _{IH})			2	μA	Digital input pins with pull-up resistor
			14	μA	Digital input pins with pull-down resistor
			2	μΑ	Digital input pins with no pull resistor
			8	μA	MCLK
			120	μΑ	SPDIFIN
Low Level (I⊥) at 0 V	-14			μΑ	Digital input pins with pull-up resistor
	-2			μA	Digital input pins with pull-down resistor
	-2			μA	Digital input pins with no pull resistor
	-8			μA	MCLK
	-120			μA	SPDIFIN
Input Capacitance (C _I)	120	2		pF	
DIGITAL OUTPUT		2		Pi	
Output Voltage					
IOVDD = 3.3 V	2.00		2.2		
High Level (V _{OH})	3.09		3.3	V	$I_{OH} = 1 \text{ mA}$
Low Level (V _{OL})	0		0.26	V	$I_{OL} = 1 \text{ mA}$
IOVDD = 1.8 V					
High Level (V _{он})	1.45		1.8	V	
Low Level (Vol)	0		0.33	V	
Digital Output Pins, Output Drive					The digital output pins are driving low impedance PCB traces to a high impedance digital input buffer
IOVDD = 1.8 V					
Drive Strength Setting					
Lowest			1	mA	The digital output pins are not designed for static current draw; do not use these pins to drive LEDs directly
Low			2	mA	The digital output pins are not designed for static current draw; do not use these pins to drive LEDs directly
High			3	mA	The digital output pins are not designed for static current draw; do not use these pins to drive LEDs directly
Highest			5	mA	The digital output pins are not designed for static current draw; do not use these pins to drive LEDs directly
IOVDD = 3.3 V					
Drive Strength Setting					
Lowest			2	mA	The digital output pins are not designed for static current draw, do not use these pins to drive LEDs directly
Low			5	mA	The digital output pins are not designed for static current draw; do not use these pins to drive LEDs directly
High			10	mA	The digital output pins are not designed for static current draw; do not use these pins to drive LEDs directly
Highest			15	mA	The digital output pins are not designed for static current draw; do not use these pins to drive LEDs directly

Auxiliary ADC

 $T_A = -40^{\circ}$ C to $+105^{\circ}$ C, DVDD = 1.2 V ± 5%, AVDD = 3.3 V ± 10%, IOVDD = 1.8 V - 5% to 3.3 V + 10%, unless otherwise noted.

Table 5.

Parameter	Min	Тур	Max	Unit	
RESOLUTION		10		Bits	
FULL-SCALE ANALOG INPUT		AVDD	V		
NONLINEARITY					
Integral Nonlinearity (INL)	-2.5		+2.5	LSB	
Differential Nonlinearity (DNL)	-2.5		+2.5	LSB	
GAIN ERROR	-2.5		+2.5	LSB	
INPUT IMPEDANCE		200	kΩ		
SAMPLE RATE		f _{core} /6144		Hz	

TIMING SPECIFICATIONS

Master Clock Input

 $T_{\rm A}$ = $-40^{\circ}C$ to $+105^{\circ}C,$ DVDD = 1.2 V \pm 5%, IOVDD = 1.8 V - 5% to 3.3 V + 10%, unless otherwise noted.

Table 6.

Parameter	Min	Тур	Max	Unit	Description
MASTER CLOCK INPUT (MCLK)					
f _{MCLK}	2.375		36	MHz	MCLK frequency
tmclk	27.8		421	ns	MCLK period
t _{MCLKD} ¹	25		75	%	MCLK duty cycle
tмсlкн	$0.25 imes t_{\text{MCLK}}$		$0.75 imes t_{\text{MCLK}}$	ns	MCLK width high
t _{MCLKL}	$0.25 imes t_{\text{MCLK}}$		$0.75 imes t_{\text{MCLK}}$	ns	MCLK width low
CLKOUT Jitter	12		106	ps	Cycle to cycle rms average
CORE CLOCK					
f _{core}	152		294.912	MHz	System (DSP core) clock frequency; PLL feedback divider ranges from 64 to 108
t _{core} ¹	3.39			ns	System (DSP core) clock period

¹ Not shown in Figure 2.

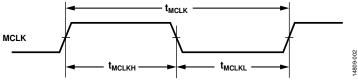


Figure 2. Master Clock Input Timing Specifications

RESET

 $T_{\rm A}$ = $-40^{\rm o}C$ to $+105^{\rm o}C,$ DVDD = 1.2 V \pm 5%, IOVDD = 1.8 V - 5% to 3.3 V + 10%.

Table 7.

Parameter	Min	Тур	Max	Unit	Description
twrst	10			ns	Reset pulse width low

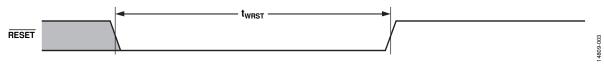


Figure 3. Reset Timing Specification

Serial Ports

 $T_{\rm A} = -40^{\circ}\text{C to} + 105^{\circ}\text{C}, \text{DVDD} = 1.2 \text{ V} \pm 5\%, \text{IOVDD} = 1.8 \text{ V} - 5\% \text{ to } 3.3 \text{ V} + 10\%, \text{unless otherwise noted. BCLK in Table 8 refers to BCLK_OUT3 to BCLK_OUT0 and BCLK_IN3 to BCLK_IN0. LRCLK refers to LRCLK_OUT3 to LRCLK_OUT0 and LRCLK_IN3 to LRCLK_IN0.$

Parameter	Min	Тур	Max	Unit	Description
f lrclk			192	kHz	LRCLK frequency
t lrclk	5.21			μs	LRCLK period
f _{BCLK}			24.576	MHz	BCLK frequency, sample rate ranging from 6 kHz to 192 kHz
t BCLK	40.7			ns	BCLK period
t _{BIL}	10			ns	BCLK low pulse width, slave mode; BCLK frequency = 24.576 MHz; BCLK period = 40.6 ns
t _{він}	14.5			ns	BCLK high pulse width, slave mode; BCLK frequency = 24.576 MHz; BCLK period = 40.6 ns
t _{LIS}	20			ns	LRCLK setup to BCLK_INx input rising edge, slave mode; LRCLK frequency = 192 kHz
tun	5			ns	LRCLK hold from BCLK_INx input rising edge, slave mode; LRCLK frequency = 192 kHz
tsis	5			ns	SDATA_INx setup to BCLK_INx input rising edge
tsih	5			ns	SDATA_INx hold from BCLK_INx input rising edge
t _{TS}			10	ns	BCLK_OUTx output falling edge to LRCLK_OUTx output timing skew, slave mode
t _{sods}			35	ns	SDATA_OUTx delay in slave mode from BCLK_OUTx output falling edge; serial outputs function in slave mode at all valid sample rates, provided that the external circuit design provides sufficient electrical signal integrity
t _{SODM}			10	ns	SDATA_OUTx delay in master mode from BCLK_OUTx output falling edge
tтм			5	ns	BCLK falling edge to LRCLK timing skew, master mode

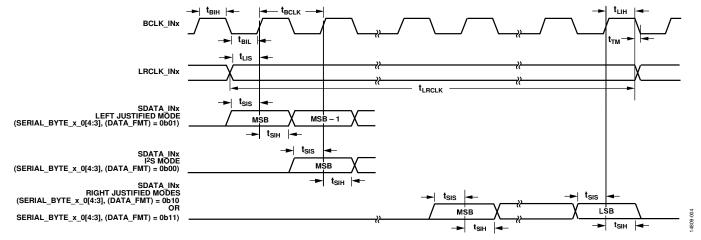


Figure 4. Serial Input Port Timing Specifications

Data Sheet

ADAU1463/ADAU1467

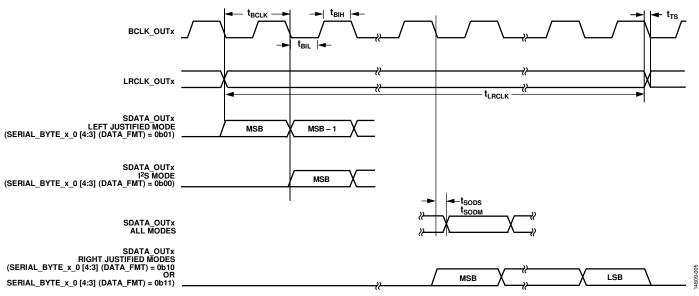


Figure 5. Serial Output Port Timing Specifications

Multipurpose Pins (MPx)

 $T_{\rm A}$ = $-40^{\rm o}C$ to $+105^{\rm o}C,$ DVDD = 1.2 V \pm 5%, IOVDD = 1.8 V - 5% to 3.3 V + 10%.

Table 9.

Parameter	Min	Тур	Max	Unit	Description
f _{MP}			24.576	MHz	MPx maximum switching rate when pin is configured as a general- purpose input or general-purpose output
t _{MPIL}	10 × t _{core}		6144 × t _{core}	sec	MPx pin input latency until high/low value is read by core; the duration in the Max column is equal to the period of one audio sample when the DSP is processing 6144 instructions per sample

S/PDIF Transmitter and Receiver

 $T_{\rm A}$ = $-40^{\rm o}C$ to $+105^{\rm o}C,$ DVDD = 1.2 V \pm 5%, IOVDD = 1.8 V - 5% to 3.3 V + 10%.

Table 10.

Parameter	Min	Тур	Max	Unit	Description
AUDIO SAMPLE RATE					
Transmitter	18		192	kHz	Audio sample rate of data output from S/PDIF transmitter
Receiver	18		192	kHz	Audio sample rate of data input to S/PDIF receiver

I²C Interface—Slave

 $T_A = -40^{\circ}C$ to $+105^{\circ}C$, DVDD = 1.2 V ± 5%, IOVDD = 1.8 V - 5% to 3.3 V + 10%.

Table 11.

Parameter	Min	Тур	Мах	Unit	Description
fscl			1000	kHz	SCL clock frequency
t _{sclH}	0.26			μs	SCL pulse width high
tscll	0.5			μs	SCL pulse width low
t _{scs}	0.26			μs	Start and repeated start condition setup time
t _{SCH}	0.26			μs	Start condition hold time
t _{DS}	50			ns	Data setup time
t _{DH}			0.45	μs	Data hold time
t _{SCLR}			120	ns	SCL rise time
tsclf			120	ns	SCL fall time
t _{SDR}			120	ns	SDA rise time
t _{SDF}			120	ns	SDA fall time
t _{BFT}	0.5			μs	Bus free time between stop and start
t susto	0.26			μs	Stop condition setup time

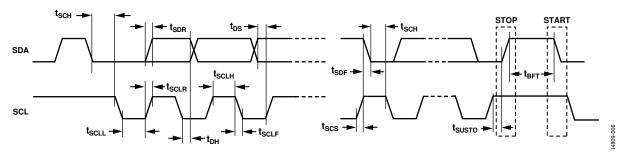


Figure 6. I²C Slave Port Timing Specifications

I²C Interface—Master

 $T_{\rm A}$ = $-40^{\circ}C$ to $+105^{\circ}C,$ DVDD = 1.2 V \pm 5%, IOVDD = 1.8 V - 5% to 3.3 V + 10%.

Table 12.

Parameter	Min	Тур	Мах	Unit	Description
f _{scl}			1000	kHz	SCL clock frequency
t _{SCLH}	0.26			μs	SCL pulse width high
tscll	0.5			μs	SCL pulse width low
t _{scs}	0.26			μs	Start and repeated start condition setup time
tsch	0.26			μs	Start condition hold time
t _{DS}	50			ns	Data setup time
t _{DH}			0.45	μs	Data hold time
t _{SCLR}			120	ns	SCL rise time
t _{SCLF}			120	ns	SCL fall time
t _{SDR}			120	ns	SDA rise time
t _{SDF}			120	ns	SDA fall time
tBFT	0.5			μs	Bus free time between stop and start
t susto	0.26			μs	Stop condition setup time

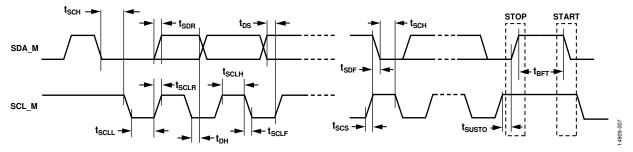


Figure 7. I²C Master Port Timing Specifications

SPI Interface—Slave

 $T_A = -40^{\circ}$ C to $+105^{\circ}$ C, DVDD = 1.2 V \pm 5%, IOVDD = 1.8 V - 5% to 3.3 V + 10%.

Table 13.

Parameter	Min	Тур	Max	Unit	Description
f _{sclk_write}			20	MHz	SCLK write frequency
fsclk_read			20	MHz	SCLK read frequency
t _{SCLKPWL}	6			ns	SCLK pulse width low, SCLK = 20 MHz
t sclkpwh	21			ns	SCLK pulse width high, SCLK = 20 MHz
t _{sss}	1			ns	SS setup to SCLK rising edge
t _{ssh}	2			ns	SS hold from SCLK rising edge
t _{sspwh}	10			ns	SS pulse width high
t _{MOSIS}	1			ns	MOSI setup to SCLK rising edge
t _{MOSIH}	2			ns	MOSI hold from SCLK rising edge
tmisod			39	ns	MISO valid output delay from SCLK falling edge

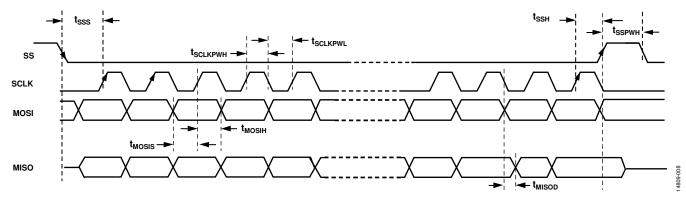


Figure 8. SPI Slave Port Timing Specifications

SPI Interface—Master

 $T_{\rm A}$ = $-40^{\circ}C$ to $+105^{\circ}C,$ DVDD = 1.2 V \pm 5%, IOVDD = 1.8 V -5% to 3.3 V + 10%.

Table 14.

Parameter	Min	Тур	Max	Unit	Description
TIMING REQUIREMENTS					
t sspidm	15			ns	MISO_M data input valid to SCLK_M edge (data input setup time)
t _{HSPIDM}	5			ns	SCLK_M last sampling edge to data input not valid (data input hold time)
SWITCHING CHARACTERISTICS					
t spiclkm	41.7			ns	SPI master clock cycle period
fsclk_m			24	MHz	SPI master clock frequency
tspichm	17			ns	SCLK_M high period ($f_{SCLK_M} = 24 \text{ MHz}$)
tspiclm	17			ns	SCLK_M low period ($f_{SCLK_M} = 24 \text{ MHz}$)
t _{ddspidm}			16.9	ns	SCLK_M edge to data out valid (data out delay time) ($f_{SCLK_M} = 24$ MHz)
t hdspidm	21			ns	SCLK_M edge to data out not valid (data out hold time) ($f_{SCLK_M} = 24$ MHz)
t _{sdscim}	36			ns	SS_M (SPI device select) low to first SCLK_M edge ($f_{SCLK_M} = 24 \text{ MHz}$)
t _{HDSM}	95			ns	Last SCLK_M edge to SS_M high ($f_{SCLK_M} = 24 \text{ MHz}$)

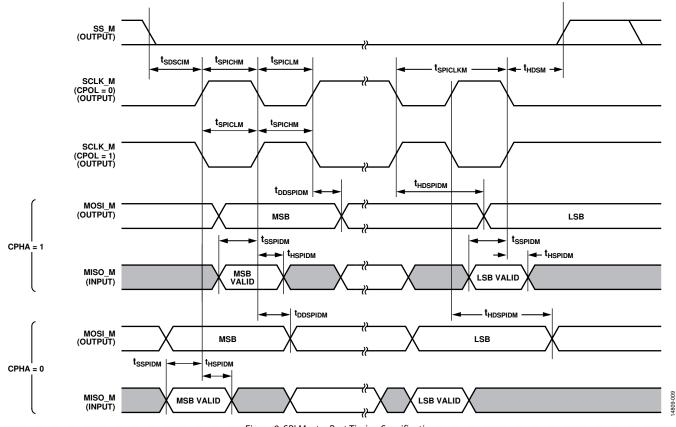


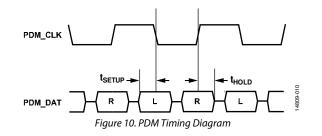
Figure 9. SPI Master Port Timing Specifications

PDM Inputs

 $T_A = -40^{\circ}C$ to $+105^{\circ}C$, DVDD $= 1.2 V \pm 5\%$, IOVDD = 1.8 V - 5% to 3.3 V + 10%. PDM data is latched on both edges of the clock (see Figure 10).

Table 15.

Parameter	t _{MIN}	t _{MAX}	Unit	Description
t _{setup}	10		ns	Data setup time
t _{HOLD}	5		ns	Data hold time



ABSOLUTE MAXIMUM RATINGS

Table 16.

Parameter	Rating
DVDD to Ground	0 V to 1.4 V
AVDD to Ground	0 V to 4.0 V
IOVDD to Ground	0 V to 4.0 V
PVDD to Ground	0 V to 4.0 V
Digital Inputs	DGND – 0.3 V to IOVDD + 0.3 V
Maximum Ambient Temperature Range	-40°C to +105°C
Maximum Junction Temperature	125°C
Storage Temperature Range	–65°C to +150°C
Soldering (10 sec)	300°C

Stresses at or above those listed under Absolute Maximum Ratings may cause permanent damage to the product. This is a stress rating only; functional operation of the product at these or any other conditions above those indicated in the operational section of this specification is not implied. Operation beyond the maximum operating conditions for extended periods may affect product reliability.

THERMAL CONSIDERATIONS

The capabilities of the ADAU1463/ADAU1467 are such that it is possible to configure the device in a mode where its power dissipation can risk exceeding the absolute maximum junction temperature. The junction temperature reached in a device is influenced by several factors, for example, the power dissipated in the device; the thermal efficiency of the printed circuit board (PCB) design; and the maximum ambient temperature supported in the application.

To ensure that the ADAU1463/ADAU1467 do not exceed the absolute maximum junction temperature in an application, thermal considerations must be taken from the start of the design (for example, likely modes of operation, thermal considerations in the PCB design (see the AN-772 Application Note), and thermal simulations) to its finish (qualification at the maximum ambient temperature supported in the application).

While all of the following thermal coefficients can be used to analyze the thermal performance of ADAU1463/ADAU1467, ψ_{TT} is the most reflective of real-world applications and is recommended as the primary approach for thermal qualification.

Table 17. Thermal Coefficients for ADAU1463/ADAU1467

Thermal Coefficient	Value	Unit
ψл ¹	0.15	°C/W
θ_{JA^1}	29.15	°C/W
θ_{JB}^2	10.59	°C/W
$\theta_{JCT}{}^3$	0.04	°C/W
$\theta_{JCB}{}^4$	3.39	°C/W

¹ Based on simulation using a JEDEC 2s2p thermal test PCB with 25 thermal vias in a JEDEC natural convection environment, as per JESD51.

² Based on simulation using a JEDEC 2s2p thermal test PCB with 25 thermal vias in a JEDEC junction to board environment, as per JESD51.

³ Based on simulation using a cold plate attached directly to the exposed pad.

To employ the ψ_{JT} -based approach to thermal analysis,

- 1. Configure the ADAU1463/ADAU1467 in the highest power mode of operation to be used in the application and record the power dissipated in the device.
- 2. Compute the maximum allowable surface temperature, T_{S_MAX}:

 $T_{S_MAX} = T_{J_MAX} - (Power \times \psi_{JT})$

- Measure the case temperature at the center of the ADAU1463/ADAU1467 package (Ts) at the maximum ambient temperature supported in the application and compare to Ts_MAX.
- 4. For safe operation, use $T_S < T_{S_MAX}$ in the highest power mode of operation in the application.

For more information, see the PCB Design Considerations section and the AN-772 Application Note, A Design and Manufacturing Guide for the Lead Frame Chip Scale Package (LFCSP).

ESD CAUTION



ESD (electrostatic discharge) sensitive device. Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

PIN CONFIGURATION AND FUNCTION DESCRIPTIONS

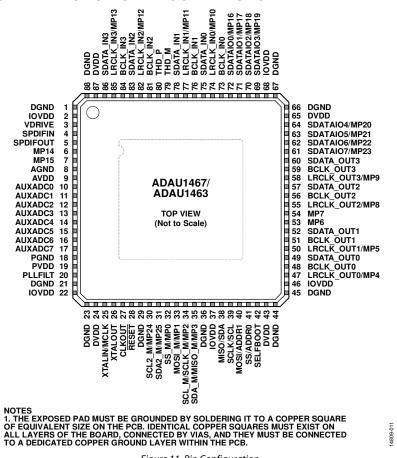


Figure 11. Pin Configuration

Table 18. Pin Function Description	15

Pin No.	Mnemonic	Internal Pull Resistor	Description
1	DGND	None	Digital and I/O Ground Reference. Tie all DGND, AGND, and PGND pins directly together in a common ground plane. See the Power Supply Bypass Capacitors section and the Grounding section.
2	IOVDD	None	Input/Output Supply, $1.8 V - 5\%$ to $3.3 V + 10\%$. Bypass this pin with decoupling capacitors to Pin 1 (DGND). See the Power Supply Bypass Capacitors section and the Grounding section.
3	VDRIVE	None	Positive Negative Positive (PNP) Bipolar Junction Transistor Base Drive Bias Pin for the Digital Supply Regulator. Connect VDRIVE to the base of an external PNP pass transistor (ON Semi NSS1C300ET4G is recommended). If an external supply is provided directly to DVDD, connect the VDRIVE pin to ground.
4	SPDIFIN	None	Input to the Integrated Sony/PDIF Receiver. Disconnect this pin when not in use. This pin is biased internally to IOVDD/2.
5	SPDIFOUT	Configurable	Output from the Integrated Sony/PDIF Transmitter. Disconnect this pin when not in use. This pin is biased internally to IOVDD/2.
6	MP14	Configurable	Multipurpose, General-Purpose Input/Output (GPIO) 14. Disconnect this pin when not in use.
7	MP15	Configurable	Multipurpose, GPIO 15. Disconnect this pin when not in use.
8	AGND	None	Analog Ground Reference for the Auxiliary ADC. Tie all DGND, AGND, and PGND pins directly together in a common ground plane. See the Power Supply Bypass Capacitors section and the Grounding section.
9	AVDD	None	Analog Supply for the Auxiliary ADC. This supply muust be 3.3 V \pm 10%. Bypass this pin with decoupling capacitors to Pin 8 (AGND). See the Power Supply Bypass Capacitors section and the Grounding section.

Pin No.	Mnemonic	Internal Pull Resistor	Description
10	AUXADC0	None	Auxiliary ADC Input Channel 0. This pin reads an analog input signal and uses its value in the DSP program. Disconnect this pin when not in use.
11	AUXADC1	None	Auxiliary ADC Input Channel 1. This pin reads an analog input signal and uses its value in the DSP program. Disconnect this pin when not in use.
12	AUXADC2	None	Auxiliary ADC Input Channel 2. This pin reads an analog input signal and uses its value in the DSP program. Disconnect this pin when not in use.
13	AUXADC3	None	Auxiliary ADC Input Channel 3. This pin reads an analog input signal and uses its value in the DSP program. Disconnect this pin when not in use.
14	AUXADC4	None	Auxiliary ADC Input Channel 4. This pin reads an analog input signal and uses its value in the DSP program. Disconnect this pin when not in use.
15	AUXADC5	None	Auxiliary ADC Input Channel 5. This pin reads an analog input signal and uses its value in the DSP program. Disconnect this pin when not in use.
16	AUXADC6	None	Auxiliary ADC Input Channel 6. This pin reads an analog input signal and uses its value in the DSP program. Disconnect this pin when not in use.
17	AUXADC7	None	Auxiliary ADC Input Channel 7. This pin reads an analog input signal and uses its value in the DSP program. Disconnect this pin when not in use.
18	PGND	None	PLL Ground Reference. Tie all DGND, AGND, and PGND pins directly together in a common ground plane. See the Power Supply Bypass Capacitors section and the Grounding section.
19	PVDD	None	PLL Supply. This supply must be $3.3 V \pm 10\%$. Bypass this pin with decoupling capacitors to Pin 18 (PGND). See the Power Supply Bypass Capacitors section and the Grounding section.
20	PLLFILT	None	PLL Filter. The voltage on the PLLFILT pin, which is internally generated, is typically between 1.65 V and 2.10 V.
21	DGND	None	Digital and I/O Ground Reference. Tie all DGND, AGND, and PGND pins directly together in a common ground plane. See the Power Supply Bypass Capacitors section and the Grounding section.
22	IOVDD	None	Input/Output Supply, 1.8 V – 5% to 3.3 V + 10%. Bypass this pin to Pin 21 (DGND) with decoupling capacitors. See the Power Supply Bypass Capacitors section and the Grounding section.
23	DGND	None	Digital and I/O Ground Reference. Tie all DGND, AGND, and PGND pins directly together in a common ground plane. See the Power Supply Bypass Capacitors section and the Grounding section.
24	DVDD	None	Digital Supply. This supply must be $1.2 V \pm 5\%$. This pin can be supplied externally or by using the internal regulator and external pass transistor. Bypass this pin to Pin 23 (DGND) with decoupling capacitors. See the Power Supply Bypass Capacitors section and the Grounding section.
25	XTALIN/MCLK	None	Crystal Oscillator Input (XTALIN)/Master Clock Input to the PLL (MCLK). This pin can be supplied directly or generated by driving a crystal with the internal crystal oscillator via Pin 26 (XTALOUT). If a crystal is used, refer to the circuit shown in Figure 14.
26	XTALOUT	None	Crystal Oscillator Output for Driving an External Crystal. If a crystal is used, refer to the circuit shown in Figure 14. Disconnect this pin when not in use.
27	CLKOUT	Configurable	Master Clock Output. This pin drives a master clock signal to other ICs in the system. CLKOUT can be configured to output a clock signal with a frequency of $1 \times, 2 \times, 4 \times, $ or $8 \times$ the frequency of the divided clock signal being input to the PLL. Disconnect this pin when not in use.
28	RESET	Pull-down	Active Low Reset Input. A reset is triggered on a high to low edge and exited on a low to high edge. A reset event sets all RAMs and registers to their default values.
29	DGND	None	Digital and I/O Ground Reference. Tie all DGND, AGND, and PGND pins directly together in a common ground plane. See the Power Supply Bypass Capacitors section and the Grounding section.
30	SCL2_M/ MP24	Pull-up; can be disabled by a write to control register	l ² C Master 2 Serial Clock Port (SCL2_M)/Multipurpose, GPIO24 (MP24). When in l ² C master mode, this pin functions as an open-collector output and drives a serial clock to slave devices on the l ² C bus. When in l ² C master mode, this pin must have a 2.0 kΩ pull-up resistor to IOVDD. When the second master control port is not being used and this pin is not needed as a GPIO, leave it disconnected.
31	SDA2_M/ MP25	Pull-up; can be disabled by a write to control register	I ² C Master 2 Serial Data Port (SCL2_M)/Multipurpose, GPIO25 (MP25). When in I ² C master mode, this pin functions as a bidirectional, open-collector data line between the I ² C master port and slave devices on the I ² C bus. Use a 2.0 kΩ pull-up resistor to IOVDD on the line connected to this pin. Disconnect this pin when not in use.

Pin		Internal Pull	
No.	Mnemonic	Resistor	Description
32	SS_M/MP0	Pull-up; nominally 250 kΩ; can be disabled by a write to control register	SPI Master/Slave Select Port (SS_M)/Multipurpose, GPIO0 (MP0). When in SPI master mode, this pin acts as the slave select signal to slave devices on the SPI bus. The pin must go low at the beginning of a master SPI transaction and high at the end of a transaction. This pin has an internal pull-up resistor that is nominally 250 k Ω . When the SELFBOOT pin is held high and the RESET pin transitions from low to high, Pin 32 sets the communications protocol for self boot operation. If this pin has a 10 k Ω pull-down resistor to DGND, the I ² C communications protocol is used for self boot operation. When self boot operation is not used and this pin is not needed as a GPIO, leave it disconnected.
33	MOSI_M/MP1	Pull-up; can be disabled by a write to control register	SPI Master Data Output Port (MOSI_M)/Multipurpose, GPIO1 (MP1). When in SPI master mode, this pin sends data from the SPI master port to slave devices on the SPI bus. Disconnect this pin when not in use.
34	SCL_M/ SCLK_M/MP2	Pull-up; can be disabled by a write to control register	I ² C Master Serial Clock Port (SCL_M)/SPI Master Mode Serial Clock (SCLK_M)/Multipurpose, GPIO2 (MP2). When in I ² C master mode, this pin functions as an open-collector output and drives a serial clock to slave devices on the I ² C bus. Use a 2.0 kΩ pull-up resistor to IOVDD on the line connected to this pin. When in SPI master mode, this pin drives the clock signal to slave devices on the SPI bus. Disconnect this pin when not in use.
35	SDA_M/ MISO_M/MP3	Pull-up; can be disabled by a write to control register	I ² C Master Port Serial Data (SDA_M)/SPI Master Mode Data Input (MISO_M)/Multipurpose, GPIO3 (MP3). When in I ² C master mode, this pin functions as a bidirectional open-collector data line between the I ² C master port and slave devices on the I ² C bus; use a 2.0 kΩ pull-up resistor to IOVDD on the line connected to this pin. When in SPI master mode, this pin receives data from slave devices on the SPI bus. Disconnect this pin when not in use.
36	DGND	None	Digital and I/O Ground Reference. Tie all DGND, AGND, and PGND pins directly together in a common ground plane. See the Power Supply Bypass Capacitors section and the Grounding section.
37	IOVDD	None	Input/Output Supply, 1.8 V – 5% to 3.3 V + 10%. Bypass this pin to Pin 36 (DGND) with decoupling capacitors. See the Power Supply Bypass Capacitors section and the Grounding section.
38	MISO/SDA	Pull-up; can be disabled by a write to control register	SPI Slave Data Output Port (MISO)/I ² C Slave Serial Data Port (SDA). In SPI slave mode, this pin outputs data to the master device on the SPI bus. In I ² C slave mode, this pin functions as a bidirectional open-collector data line between the I ² C slave port and the master device on the I ² C bus. Use a 2.0 k Ω pull-up resistor to IOVDD on the line connected to this pin. When this pin is not in use, connect it to IOVDD with a 10.0 k Ω pull-up resistor.
39	SCLK/SCL	Pull-up; can be disabled by a write to control register	SPI Slave Port Serial Clock (SCLK)/I ² C Slave Port Serial Clock (SCL). In SPI slave mode, this pin receives the serial clock signal from the master device on the SPI bus. In I ² C slave mode, this pin receives the serial clock signal from the master device on the I ² C bus. Use a 2.0 k Ω pull-up resistor to IOVDD on the line connected to this pin. When this pin is not in use, connect it to IOVDD with a 10.0 k Ω pull-up resistor.
40	MOSI/ADDR1	Pull-up; can be disabled by a write to control register	SPI Slave Port Data Input (MOSI)/I ² C Slave Port Address MSB (ADDR1). In SPI slave mode, this pin receives a data signal from the master device on the SPI bus. In I ² C slave mode, this pin acts as an input and sets the chip address of the I ² C slave port, in conjunction with Pin 41 (SS/ADDR0).
41	SS/ADDR0	Pull-up, nomi- nally 250 kΩ; can be disabled by a write to control register	SPI Slave Port Slave Select (SS)/I ² C Slave Port Address LSB (ADDR0). In SPI slave mode, this pin receives the slave select signal from the master device on the SPI bus. In I ² C slave mode, this pin acts as an input and sets the chip address of the I ² C slave port in conjunction with Pin 40 (MOSI/ADDR1).
42	SELFBOOT	Pull-up	Self Boot Select. This pin allows the device to perform a self boot, in which it loads its RAM and register settings from an external EEPROM. Connecting Pin 37 to logic high (IOVDD) initiates a self boot operation the next time there is a rising edge on Pin 24 (RESET). When this pin is connected to ground, no self boot operation is initiated. This pin can be connected to IOVDD or to ground either directly or pulled up or down with a 1.0 k Ω or larger resistor.
43	DVDD	None	Digital Supply. This supply must be 1.2 V \pm 5%. This pin can be supplied externally or by using the internal regulator and external pass transistor. Bypass this pin to Pin 36 (DGND) with decoupling capacitors. See the Power Supply Bypass Capacitors section and the Grounding section.

Pin		Internal Pull	
No.	Mnemonic	Resistor	Description
44	DGND	None	Digital and I/O Ground Reference. Tie all DGND, AGND, and PGND pins directly together in a common ground plane. See the Power Supply Bypass Capacitors section and the Grounding section.
45	DGND	None	Digital and I/O Ground Reference. Tie all DGND, AGND, and PGND pins directly together in a common ground plane. See the Power Supply Bypass Capacitors section and the Grounding section.
46	IOVDD	None	Input/Output Supply, 1.8 V – 5% to 3.3 V + 10%. Bypass this pin with decoupling capacitors to Pin 45 (DGND). See the Power Supply Bypass Capacitors section and the Grounding section.
47	LRCLK_OUT0/ MP4	Configurable	Frame Clock, Serial Output Port 0 (LRCLK_OUT0)/Multipurpose, GPIO4 (MP4). This pin is bidirectional, with the direction depending on whether Serial Output Port 0 is a master or slave. Disconnect this pin when not in use.
48	BCLK_OUT0	Configurable	Bit Clock, Serial Output Port 0. This pin is bidirectional, with the direction depending on whether the Serial Output Port 0 is a master or slave. Disconnect this pin when not in use.
49	SDATA_OUT0	Configurable	Serial Data Output Port 0 (Channel 0 to Channel 15). Capable of 2-channel, 4-channel, 8-channel, and 16-channel modes. Disconnect this pin when not in use.
50	LRCLK_OUT1/ MP5	Configurable	Frame Clock, Serial Output Port 1 (LRCLK_OUT1)/Multipurpose, GPIO5 (MP5). This pin is bidirectional, with the direction depending on whether Serial Output Port 1 is a master or slave. Disconnect this pin when not in use.
51	BCLK_OUT1	Configurable	Bit Clock, Serial Output Port 1. This pin is bidirectional, with the direction depending on whether Output Serial Port 1 is a master or slave. Disconnect this pin when not in use.
52	SDATA_OUT1	Configurable	Serial Data Output Port 1 (Channel 16 to Channel 31). Capable of 2-channel, 4-channel, 8-channel, and 16-channel modes. Disconnect this pin when not in use.
53	MP6	Configurable	Multipurpose, GPIO 6. Disconnect this pin when not in use.
54	MP7	Configurable	Multipurpose, GPIO 7. Disconnect this pin when not in use.
55	LRCLK_OUT2/ MP8	Configurable	Frame Clock, Serial Output Port 2 (LRCLK_OUT2)/Multipurpose, GPIO8 (MP8). This pin is bidirectional, with the direction depending on whether Serial Output Port 2 is a master or slave. Disconnect this pin when not in use.
56	BCLK_OUT2	Configurable	Bit Clock, Serial Output Port 2. This pin is bidirectional, with the direction depending on whether Serial Output Port 2 is a master or slave. Disconnect this pin when not in use.
57	SDATA_OUT2	Configurable	Serial Data Output Port 2 (Channel 32 to Channel 39). Capable of 2-channel, 4-channel, 8-channel, and flexible TDM modes. Disconnect this pin when not in use.
58	LRCLK_OUT3/ MP9	Configurable	Frame Clock, Serial Output Port 3 (LRCLK_OUT3)/Multipurpose, GPIO9 (MP9). This pin is bidirectional, with the direction depending on whether Serial Output Port 3 is a master or slave. Disconnect this pin when not in use.
59	BCLK_OUT3	Configurable	Bit Clock, Serial Output Port 3. This pin is bidirectional, with the direction depending on whether Serial Output Port 3 is a master or slave. Disconnect this pin when not in use.
60	SDATA_OUT3	Configurable	Serial Data Output Port 3 (Channel 40 to Channel 47). Capable of 2-channel, 4-channel, 8-channel, and flexible TDM modes. Disconnect this pin when not in use.
61	SDATAIO7/ MP23	Configurable	Serial Data Assignable Input/Output Port 7. Capable of 2-channel, 4-channel, 8-channel, or 16-channel mode, synchronous with a serial input or serial output port. Disconnect this pin when not in use.
62	SDATAIO6/ MP22	Configurable	Serial Data Assignable Input/Output Port 6. Capable of 2-channel, 4-channel, 8-channel, or 16-channel mode, synchronous with a serial input or serial output port. Disconnect this pin when not in use.
63	SDATAIO5/ MP21	Configurable	Serial Data Assignable Input/Output Port 5. Capable of 2-channel, 4-channel, 8-channel, or 16-channel mode, synchronous with a serial input or serial output port. Disconnect this pin when not in use.
64	SDATAIO4/ MP20	Configurable	Serial Data Assignable Input/Output Port 4. Capable of 2-channel, 4-channel, 8-channel, or 16-channel mode, synchronous with a serial input or serial output port. Disconnect this pin when not in use.
65	DVDD	None	Digital Supply. This supply must be $1.2 V \pm 5\%$. This pin can be supplied externally or by using the internal regulator and external pass transistor. Bypass Pin 65 with decoupling capacitors to Pin 66 (DGND). See the Power Supply Bypass Capacitors section and the Grounding section.
66	DGND	None	Digital and I/O Ground Reference. Tie all DGND, AGND, and PGND pins directly together in a common ground plane. See the Power Supply Bypass Capacitors section and the Grounding section.

Pin	Maamania	Internal Pull	Description
No.	Mnemonic	Resistor	
67	DGND	None	Digital and I/O Ground Reference. Tie all DGND, AGND, and PGND pins directly together in a common ground plane. See the Power Supply Bypass Capacitors section and the Grounding section.
68	IOVDD	None	Input/Output Supply, 1.8 V – 5% to 3.3 V + 10%. Bypass this pin with decoupling capacitors to Pin 67 (DGND). See the Power Supply Bypass Capacitors section and the Grounding section.
69	SDATAIO3/ MP19	Configurable	Serial Data Assignable Input/Output Port 3. Capable of 2-channel, 4-channel, 8-channel, or 16-channel mode, synchronous with a serial input or serial output port. Disconnect this pin when not in use.
70	SDATAIO2/ MP18	Configurable	Serial Data Assignable Input/Output Port 2. Capable of 2-channel, 4-channel, 8-channel, or 16-channel mode, synchronous with a serial input or serial output port. Disconnect this pin when not in use.
71	SDATAIO1/ MP17	Configurable	Serial Data Assignable Input/Output Port 1. Capable of 2-channel, 4-channel, 8-channel, or 16-channel mode, synchronous with a serial input or serial output port. Disconnect this pin when not in use.
72	SDATAIO0/ MP16	Configurable	Serial Data Assignable Input/Output Port 1. Capable of 2-channel, 4-channel, 8-channel, or 16-channel mode, synchronous with a serial input or serial output port. Disconnect this pin when not in use.
73	BCLK_IN0	Configurable	Bit Clock, Serial Input Port 0. This pin is bidirectional, with the direction depending on whether Serial Input Port 0 is a master or slave. Disconnect this pin when not in use.
74	LRCLK_IN0/ MP10	Configurable	Frame Clock, Serial Input Port 0 (LRCLK_IN0)/Multipurpose, GPIO10 (MP10). This pin is bidirectional, with the direction depending on whether Serial Input Port 0 is a master or slave. Disconnect this pin when not in use.
75	SDATA_IN0	Configurable	Serial Data Input Port 0 (Channel 0 to Channel 15). Capable of 2-channel, 4-channel, 8-channel, or 16-channel mode. Disconnect this pin when not in use.
76	BCLK_IN1	Configurable	Bit Clock, Serial Input Port 1. This pin is bidirectional, with the direction depending on whether the Serial Input Port 1 is a master or slave. Disconnect this pin when not in use.
77	LRCLK_IN1/ MP11	Configurable	Frame Clock, Serial Input Port 1 (LRCLK_IN1)/Multipurpose, GPIO11 (MP11). This pin is bidirectional, with the direction depending on whether the Serial Input Port 1 is a master or slave. Disconnect this pin when not in use.
78	SDATA_IN1	Configurable	Serial Data Input Port 1 (Channel 16 to Channel 31). Capable of 2-channel, 4-channel, 8-channel, or 16-channel mode. Disconnect this pin when not in use.
79	THD_M	None	Thermal Diode Negative Input. Connect this pin to the negative diode (D– pin) of an external temperature sensor IC. Disconnect this pin when not in use.
80	THD_P	None	Thermal Diode Positive Input. Connect this pin to the positive diode (D+ pin) of an external temperature sensor IC. Disconnect this pin when not in use.
81	BCLK_IN2	Configurable	Bit Clock, Serial Input Port 2. This pin is bidirectional, with the direction depending on whether the Serial Input Port 2 is a master or slave. Disconnect this pin when not in use.
82	LRCLK_IN2/ MP12	Configurable	Frame Clock, Input Serial Port 2 (LRCLK_IN2)/Multipurpose, GPIO12 (MP12). This pin is bidirectional, with the direction depending on whether Serial Input Port 2 is a master or slave. Disconnect this pin when not in use.
83	SDATA_IN2	Configurable	Serial Data Input Port 2 (Channel 32 to Channel 39). Capable of 2-channel, 4-channel, 8-channel, or flexible TDM mode. Disconnect this pin when not in use.
84	BCLK_IN3	Configurable	Bit Clock, Input Serial Port 3. This pin is bidirectional, with the direction depending on whether Input Serial Port 3 is a master or slave. Disconnect this pin when not in use.
85	LRCLK_IN3/ MP13	Configurable	Frame Clock, Serial Input Port 3 (LRCLK_IN3)/Multipurpose, GPIO13 (MP13). This pin is bidirectional, with the direction depending on whether Serial Input Port 3 is a master or slave. Disconnect this pin when not in use.
86	SDATA_IN3	Configurable	Serial Data Input Port 3 (Channel 40 to Channel 47). Capable of 2-channel, 4-channel, 8-channel, or flexible TDM mode. Disconnect this pin when not in use.
87	DVDD	None	Digital Supply. This supply must be 1.2 V \pm 5%. This pin can be supplied externally or by using the internal regulator and external pass transistor. Bypass with decoupling capacitors to Pin 88 (DGND). See the Power Supply Bypass Capacitors section and the Grounding section.
88	DGND	None	Digital and I/O Ground Reference. Tie all DGND, AGND, and PGND pins directly together in a common ground plane. See the Power Supply Bypass Capacitors section and the Grounding section.

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Pin No.	Mnemonic	Internal Pull Resistor	Description
	EP	None	Exposed Pad. The exposed pad must be grounded by soldering it to a copper square of equivalent size on the PCB. Identical copper squares must exist on all layers of the board, connected by vias, and they must be connected to a dedicated copper ground layer within the PCB. See Figure 86 and Figure 87.

THEORY OF OPERATION SYSTEM BLOCK DIAGRAM

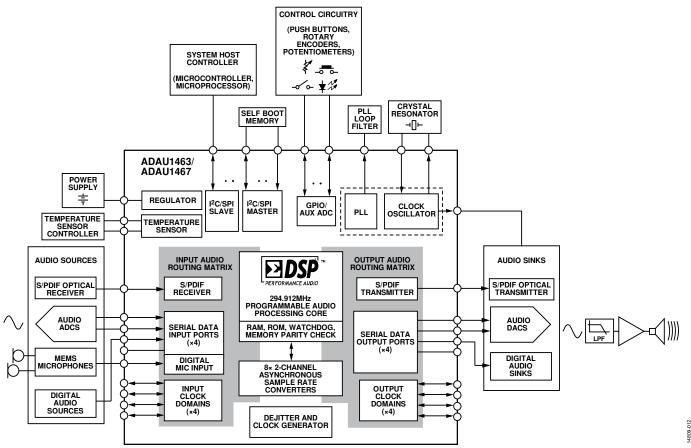


Figure 12. System Block Diagram with Example Connections to External Components

OVERVIEW

The ADAU1463/ADAU1467 are enhanced audio processors with 48 channels of input and output. They include options for the hardware routing of audio signals between the various inputs, outputs, SigmaDSP core, and integrated sample rate converters. The SigmaDSP core features full 32-bit processing (that is, 64-bit processing in double precision mode) with an 80-bit arithmetic logic unit (ALU). By using a quadruple multiply accumulator (MAC) data path, the ADAU1463/ADAU1467 can execute more than 1.2 billion MAC operations per second, which allows processing power that far exceeds predecessors in the SigmaDSP family of products. The powerful DSP core can process over 3000 double precision biquad filters or 24,000 FIR filter taps per sample at the standard 48 kHz audio sampling rate. Other features, including synchronous parameter loading for ensuring filter stability and 100% code efficiency with the SigmaStudio tools, reduce complexity in audio system development. The SigmaStudio library of audio processing algorithms allows system designers to compensate for real-world limitations of speakers, amplifiers, and listening environments, through speaker equalization, multiband compression, limiting, and third party branded algorithms.

The input audio routing matrix and output audio routing matrix allow the user to multiplex inputs from multiple sources that are running at various sample rates to or from the SigmaDSP core, and then to pass them on to the desired hardware outputs. This multiplexing drastically reduces the complexity of signal routing and clocking issues in the audio system. The audio subsystem includes eight stereo ASRCs, S/PDIF input and output, and serial audio data ports supporting two to 16 channels in formats such as I²S and time division multiplexing (TDM). Any of the inputs can be routed to the SigmaDSP core or to any of the ASRCs. Similarly, the output signals can be taken from the SigmaDSP core, any of the ASRC outputs, the serial inputs, the PDM microphones, or the S/PDIF receiver. This routing scheme, which can be modified at any time using control registers, allows maximum system flexibility without requiring hardware design changes.

Two serial input ports and two serial output ports can operate as pairs in a special flexible TDM mode, allowing the user to assign byte specific locations independently to audio streams at varying bit depths. This mode ensures compatibility with codecs that use similar flexible TDM streams.

The DSP core is optimized for audio processing, and it can process audio at sample rates of up to 192 kHz. The program

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and parameter/data RAMs can be loaded with a custom audio processing signal flow built with the SigmaStudio graphical programming software from Analog Devices, Inc., which is available for download at www.analog.com. The values that are stored in the parameter RAM can control individual signal processing blocks, such as infinite impulse response (IIR) and finite impulse response (FIR) equalization filters, dynamics processors, audio delays, and mixer levels. A software safeload feature allows transparent parameter updates and prevents clicks on the output signals.

Reliability features, such as memory parity checking and a program counter watchdog, help ensure that the system can detect and recover from any errors related to memory corruption.

On the ADAU1463/ADAU1467, the audio data in an S/PDIF stream can be routed through an ASRC for processing in the DSP or can be sent directly to a serial audio output. Other components of the stream, including status and user bits, are not lost and can be used in algorithm or output on the MPx pins. The user can also independently program the nonaudio data that is embedded in the output signal of the S/PDIF transmitter.

The 26 MPx pins are available to provide a simple user interface without the need for an external microcontroller. These multipurpose pins are available to input external control signals and output flags or controls to other devices in the system. As inputs, the MPx pins can be connected to push buttons, switches, rotary encoders, or other external control circuitry to control the internal signal processing program. When configured as outputs, these pins can drive LEDs (with a buffer), output flags to a microcontroller, control other ICs, or connect to other external circuitry in an application. In addition to the multipurpose pins, eight dedicated input pins (AUXADC7 to AUXADC0) are connected to an auxiliary ADC for use with analog controls such as potentiometers or system voltages.

The SigmaStudio software programs and controls the device through the control port. In addition to designing and tuning a signal flow, the software can configure all of the DSP registers in real time and download a new program and parameters into the external self boot EEPROM. The SigmaStudio graphical interface allows anyone with audio processing knowledge to design a DSP signal flow and export production quality code without the need for writing text code. The software provides enough flexibility and programmability to allow an experienced DSP programmer to have in depth control of the design. Algorithms are created in SigmaStudio by dragging and dropping signal processing cells from the library, connecting them together in a flow, compiling the design, and downloading the executable program and parameters to the SigmaDSP memory through the control port. The tasks of linking, compiling, and downloading the project are all handled automatically by the software.

The signal processing cells included in the library range from primitive operations, such as addition and gain, to large and highly optimized building blocks. For example, the libraries include the following:

- Single and double precision biquad filter
- Single-channel and multichannel dynamics processors with peak or rms detection
- Mixer and splitter
- Tone and noise generator
- Fixed and variable gain
- Loudness
- Delay
- Stereo enhancement
- Dynamic bass boost
- Noise and tone source
- Level detector
- MPx pin control and conditioning
- FFT and frequency domain processing algorithms

Analog Devices continuously develops new processing algorithms and provides proprietary and third party algorithms for applications such as matrix decoding, bass enhancement, and surround virtualizers.

Several power saving mechanisms are available, including programmable pad strength for digital I/O pins and the ability to power down unused subsystems.

Fabricated on a single monolithic integrated circuit for operation over the -40° C to $+105^{\circ}$ C temperature range, the device is housed in an 88-lead LFCSP package with an exposed pad to assist in heat dissipation.

The device can be controlled in one of two operational modes, as follows:

- Executable code and parameters can be loaded and dynamically updated through the SPI/I²C port via SigmaStudio or a microcontroller in the system.
- The DSP can self boot from an external EEPROM in a system with no microcontroller.